



Product Change Notification

Change Notification #: 114651 - 00
Change Title: Intel® NUC Board NUC5i5MYBE, and Intel® NUC Kit NUC5i5MYHE
PCN 114651-00, Product Design, BIOS Update and Header Removal
Date of Publication: May 27, 2016

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Jun 20, 2016
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Description of Change to the Customer:

The Intel® NUC Kit SKUs listed in the products affected table below will have the following changes.

- The BIOS will be updated from MYBDWI5V.86A.0026 to MYBDWI5V.86A.0029. To access the release notes or get a copy of the BIOS for evaluation, go to <http://downloadcenter.intel.com>.
- The NFC header is being removed.

Customer Impact of Change and Recommended Action:

It is recommended that customers evaluate this new BIOS to ensure a smooth transition. This change has been thoroughly evaluated to ensure that there are no quality or reliability implications to our customers. Intel validation of a new board revision does not include testing with older versions of BIOS.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change SA	Pre Change AA	Post Change SA	Post Change AA
BLKNUC5I5MYHE	938688	H47796-205	H47797-205	H47796-206	H47797-206
BLKNUC5I5MYBE	938713		H47797-205		H47797-206

PCN Revision History:

Date of Revision: May 27, 2016	Revision Number: 00	Reason: Originally Published PCN
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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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